L	Hits	S ar h Text	DB	Tim stamp
Number			LIODAT	0000/07/00
3	1	tinipt	USPAT;	2003/07/08
_			US-PGPUB	11:26
4	15	tinipd	USPAT;	2003/07/08
			US-PGPUB	11:27
5	13	tiniag	USPAT;	2003/07/08
			US-PGPUB	11:29
6	752775	@ad>19990425 @rlad>19990425	USPAT;	2003/07/08
		@pt1d>19990425	US-PGPUB	11:30
7	9	tiniag not (@ad>19990425 @rlad>19990425	USPAT;	2003/07/08
		@pt1d>19990425)	US-PGPUB	11:32
8	0	tinirh	USPAT;	2003/07/08
			US-PGPUB	11:43
9	12	tiniau	USPAT;	2003/07/08
			US-PGPUB	11:43
10	7	tiniau not (@ad>19990425 @rlad>19990425	USPAT;	2003/07/08
		@pt1d>19990425)	US-PGPUB	11:44
11	• 1	ti/ni/pt	USPAT;	2003/07/08
			US-PGPUB	11:46
12	0	tin/ni/pd	USPAT;	2003/07/08
		_	US-PGPUB	11:46
13	9	ti/ni/ag	USPAT;	2003/07/08
			US-PGPUB	11:46
14	3	ti/ni/ag not (@ad>19990425 @rlad>19990425	USPAT;	2003/07/08
		@pt1d>19990425)	US-PGPUB	11:52
15	0	ti/ni/rh	USPAT;	2003/07/08
			US-PGPUB	11:52
16	75	ti/ni/au	USPAT;	2003/07/08
			US-PGPUB	11:52
17	48	ti/ni/au not (@ad>19990425 @rlad>19990425	USPAT;	2003/07/08
		@pt1d>19990425)	US-PGPUB	11:58
18	o	ti/ni with gold adj alloy	USPAT;	2003/07/08
		dring gold day alloy	US-PGPUB	11:59
19	0	cr/ni/pt	USPAT;	2003/07/08
			US-PGPUB	11:59
20	o	cr/ni/pd	USPAT;	2003/07/08
20		Olympia and a second a second and a second a	US-PGPUB	11:59
21	5	cr/ni/ag	USPAT;	2003/07/08
~-			US-PGPUB	11:59
22	4	cr/ni/ag not (@ad>19990425 @rlad>19990425	USPAT;	2003/07/08
~_	7	@pt1d>19990425)	US-PGPUB	12:02
23	0	cr/ni/rh	USPAT;	2003/07/08
23		Civiliani	1	12:02
24	2	mo/ni/pt	US-PGPUB USPAT;	2003/07/08
47	_	iiio/iii/pt	US-PGPUB	12:03
25	2	mo/ni/pd	l .	
43	2	mo/m/pa	USPAT;	2003/07/08
26		ma/ni/au	US-PGPUB	12:03
26	0	mo/ni/ag	USPAT;	2003/07/08
27	_	and family lab	US-PGPUB	12:03
27	2	m /ni/rh	USPAT;	2003/07/08
	<u> </u>		US-PGPUB	12:04

28	0	titanium/nickel/palladium	USPAT;	2003/07/08
		_	US-P PUB	12:04
29	0	titanium/nick l/platinum	USPAT;	2003/07/08
		-	U -PGPUB	12:05
30	106	titanium adj nickel adj palladium	USPAT;	2003/07/08
			US-PGPUB	12:05
31	496066	semiconductor integrated adj circuit ic	USPAT;	2003/07/08
			US-PGPUB	12:06
32	54	(titanium adj nickel adj palladium) and	USPAT;	2003/07/08
		(semiconductor integrated adj circuit ic)	US-PGPUB	12:06
33	24	((titanium adj nickel adj palladium) and	USPAT;	2003/07/08
		(semiconductor integrated adj circuit ic))	US-PGPUB	12:06
		not (@ad>19990425 @rlad>19990425		
		@pt1d>19990425)		
35	2	(US-5821627-\$ or US-4857671-\$).did.	USPAT	2003/07/08
				13:35